FLAT-BASE TYPE INSULATED PACKAGE

PM75RL1A060



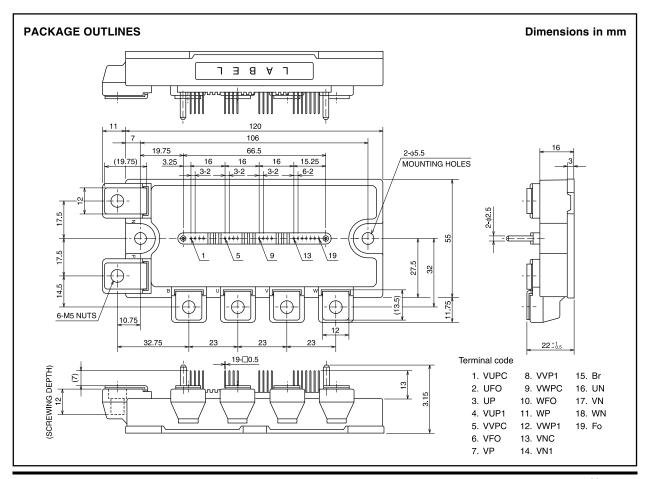
FEATURE

Inverter + Brake + Drive & Protection IC

- a) Adopting new 5th generation Full-Gate $\mathsf{CSTBT}^\mathsf{TM}$ chip
- b) The over-temperature protection which detects the chip surface temperature of $\mathsf{CSTBT^{TM}}$ is adopted.
- c) Error output signal is possible from all each protection upper and lower arm of IPM.
- d) Compatible L-series package.
 - 3¢ 75A, 600V Current-sense and temperature sense IGBT type inverter
 - Monolithic gate drive & protection logic
 - Detection, protection & status indication circuits for, shortcircuit, over-temperature & under-voltage (P-Fo available from upper arm devices)
 - UL Recognized

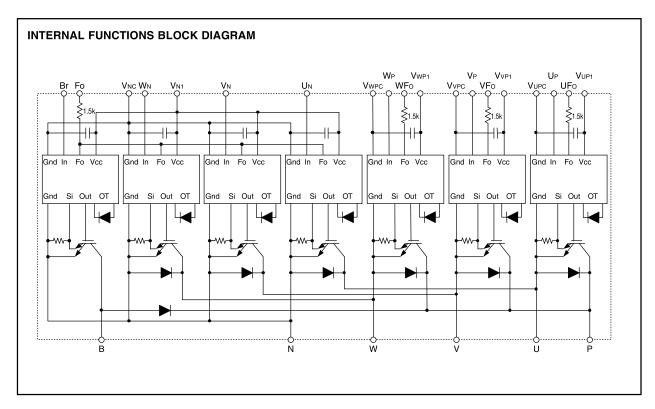
APPLICATION

General purpose inverter, servo drives and other motor controls





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MAXIMUM RATINGS (Tj = 25°C, unless otherwise noted)

INVERTER PART

Symbol	Parameter	Condition	Ratings	Unit
VCES	Collector-Emitter Voltage	VD = 15V, VCIN = 15V	600	٧
±ΙC	Collector Current	$Tc = 25^{\circ}C$ (Note-1)	75	Α
±ICP	Collector Current (Peak)	Tc = 25°C	150	Α
Pc	Collector Dissipation	$Tc = 25^{\circ}C$ (Note-1)	337	W
Tj	Junction Temperature		-20 ~ +150	°C

^{*:} To measurement point is just under the chip.

BRAKE PART

Symbol	Parameter	Condition	Ratings	Unit
VCES	Collector-Emitter Voltage	VD = 15V, VCIN = 15V	600	V
Ic	Collector Current	$Tc = 25^{\circ}C$ (Note-1)	50	Α
ICP	Collector Current (Peak)	Tc = 25°C	100	Α
Pc	Collector Dissipation	$Tc = 25^{\circ}C$ (Note-1)	284	W
lF	FWDi Forward Current	Tc = 25°C	50	Α
VR(DC)	FWDi Rated DC Reverse Voltage	Tc = 25°C	600	V
Tj	Junction Temperature		-20 ~ +150	°C

CONTROL PART

Symbol	Parameter	Condition	Ratings	Unit
VD	Supply Voltage	Applied between: VuP1-VuPc, VvP1-VvPc VwP1-VwPc, Vn1-Vnc	20	V
VCIN	Input Voltage	Applied between : UP-VUPC, VP-VVPC, WP-VWPC UN • VN • WN • Br-VNC	20	V
VFO	Fault Output Supply Voltage	Applied between : UFO-VUPC, VFO-VVPC, WFO-VWPC FO-VNC	20	٧
IFO	Fault Output Current	Sink current at UFO, VFO, WFO, FO terminals	20	mA



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(unit: mm)

TOTAL SYSTEM

Symbol	Parameter	Condition	Ratings	Unit
VCC(PROT)	Supply Voltage Protected by SC	V _D = 13.5 ~ 16.5V Inverter Part, T _j = +125°C Start	400	V
VCC(surge)	Supply Voltage (Surge)	Applied between : P-N, Surge value	500	V
Tstg	Storage Temperature		− 40 ~ +125	°C
Viso	Isolation Voltage	60Hz, Sinusoidal, Charged part to Base, AC 1 min.	2500	Vrms

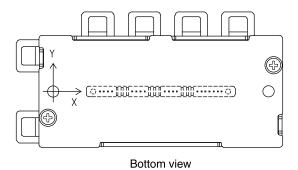
THERMAL RESISTANCES

		Condition					
Symbol	Parameter	Condition		Min.	Тур.	Max.	Unit
Rth(j-c)Q		Inverter IGBT part (per 1 element)	(Note-1)	_	_	0.37	
Rth(j-c)F	Junction to case Thermal	Inverter FWDi part (per 1 element)	(Note-1)	_	_	0.63	
Rth(j-c)Q	Resistances	Brake IGBT part	(Note-1)	_	_	0.44	°C/W
Rth(j-c)F	1	Brake FWDi upper part	(Note-1)	_	_	0.75	1 -0/00
Du. / . O	Contact Thermal Resistance	Case to fin, (per 1 module)				0.000	1
Rth(c-f)		Thermal grease applied	(Note-1)		0.038		

^{*} If you use this value, Rth(f-a) should be measured just under the chips.

(Note-1) Tc (under the chip) measurement point is below.

arm	U	P	V	Р	W	/P	U	N	V	N	W	/N	В	R
axis	IGBT	FWDi	IGBT	Di										
Х	27.9	27.9	66.2	66.2	85.8	85.8	37.4	37.4	56.1	56.1	74.7	74.7	20.2	21.3
Υ	-6.2	0.2	-6.2	0.2	-6.2	0.2	5.4	-0.8	5.4	-0.8	5.4	-0.8	-7.4	5.8



ELECTRICAL CHARACTERISTICS (Tj = 25° C, unless otherwise noted) **INVERTER PART**

Limits Unit Condition Symbol Parameter Min. Мах. Тур. Collector-Emitter Saturation Tj = 25°C VD = 15V, IC = 75A2.35 1.75 VCE(sat) ٧ Voltage VCIN = 0V, Pulsed Tj = 125°C 1.75 2.35 VEC FWDi Forward Voltage -IC = 75A, VD = 15V, VCIN = 15V(Fig. 2) 1.7 2.8 ٧ ton 0.3 8.0 2.0 VD = 15V, $VCIN = 0V \leftrightarrow 15V$ 0.4 8.0 trr Vcc = 300V, Ic = 75A 1.0 Switching Time 0.4 μs tc(on) Tj = 125°C 1.0 2.3 toff Inductive Load (Fig. 3,4) tc(off) 0.3 1.0 Collector-Emitter Cutoff Tj = 25°C ICES VCE = VCES, VD = 15V (Fig. 5) mΑ Tj = 125°C Current 10



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BRAKE PART

0	D	Condition		l lmit			
Symbol	Parameter	Condition	Min.	Тур.	Max.	Unit	
1/05/ "	Collector-Emitter Saturation	VD = 15V, IC = 50A	Tj = 25°C	_	1.75	2.35	V
VCE(sat)	Voltage	VCIN = 0V, Pulsed (Fig. 1)	Tj = 125°C	_	1.75	2.35	\ \ \
VEC	FWDi Forward Voltage	-IC = 50A, VCIN = 15V, VD = 15V	(Fig. 2)	_	1.7	2.8	V
loco	Collector-Emitter Cutoff	VcE = VcEs, VD = 15V (Fig. 5)	Tj = 25°C	_	_	1	A
ICES	Current	VCE = VCES, VD = 15V (Fig. 5)	Tj = 125°C	_	_	10	mA

CONTROL PART

Cumahaal	Daniel and Alexander	Constitute of			Lloit		
Symbol	Parameter	Condition	Min.	Тур.	Max.	Unit	
ID	Circuit Current	VD = 15V, VCIN = 15V	Vn1-Vnc	_	8	16	A
l in	Circuit Current	VD = 13V, VCIN = 13V	V*P1-V*PC	_	2	4	mA
Vth(ON)	Input ON Threshold Voltage	Applied between: UP-VUPC, VP-VVPC, V	Wp-Vwpc	1.2	1.5	1.8	V
Vth(OFF)	Input OFF Threshold Voltage	Un • Vn • Wn • Br-Vn	1C	1.7	2.0	2.3	V
00	C Short Circuit Trip Level	$-20 \le T_i \le 125^{\circ}C$, $VD = 15V$ (Fig. 3.6)	Inverter part	150	_	_	۸
150		$-20 \le 11 \le 125 \text{ C}, \text{ VD} = 15 \text{ V} \text{ (Fig. 3,6)}$	Brake part	100	_	_	A
toff(SC)	Short Circuit Current Delay Time	VD = 15V	(Fig. 3,6)	_	0.2	_	μs
ОТ	Over Temperature Protection	Detect Temperature of ICPT chin	Trip level	135	_	_	°C
OT(hys)	Over Temperature Protection	Detect Temperature of IGBT chip	Hysteresis	_	20	_	1 1
UV	Supply Circuit Under-Voltage	–20 ≤ T _i ≤ 125°C	Trip level	11.5	12.0	12.5	V
UVr	Protection	-20 ≤ 1j ≤ 125 C	Reset level	_	12.5	_	V
IFO(H)	Fault Output Current	VD = 15V, VCIN = 15V	(Note-2)	_	_	0.01	mA
IFO(L)	Tradit Odtput Gurrent	VD = 13V, VCIN = 13V	(NOIE-2)	_	10	15	IIIA
tFO	Minimum Fault Output Pulse Width	VD = 15V	(Note-2)	1.0	1.8	_	ms

(Note-2) Fault output is given only when the internal SC, OT & UV protections schemes of either upper or lower arm device operate to protect it.

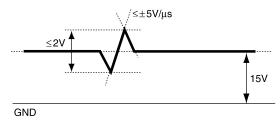
MECHANICAL RATINGS AND CHARACTERISTICS

	D	Condition	Condition			Limits			
Symbol	Parameter	Condition		Min.	Тур.	Max.	Unit		
_	Mounting torque	Mounting part screw	w : M5	2.5	3.0	3.5	N•m		
_	Mounting torque	Main terminal part screw	w : M5	2.5	3.0	3.5	N•m		
_	Weight	_		_	380	_	g		

RECOMMENDED CONDITIONS FOR USE

Symbol	Parameter	Condition	Recommended value	Unit
Vcc	Supply Voltage	Applied across P-N terminals	≤ 400	V
VD	Control Supply Voltage	Applied between : VuP1-VuPC, VvP1-VvPC VWP1-VWPC, VN1-VNC (Note-3)	15.0 ± 1.5	>
VCIN(ON)	Input ON Voltage	Applied between: UP-VuPc, VP-VvPc, WP-VwPc	≤ 0.8	\ \
VCIN(OFF)	Input OFF Voltage	Un • Vn • Wn • Br-Vnc	≥ 9.0	\ \ \
fPWM	PWM Input Frequency	Using Application Circuit of Fig. 8	≤ 20	kHz
tdead	Arm Shoot-through Blocking Time	For IPM's each input signals (Fig. 7)	≥ 2.0	μs

(Note-3) With ripple satisfying the following conditions: dv/dt swing $\leq \pm 5V/\mu s$, Variation $\leq 2V$ peak to peak



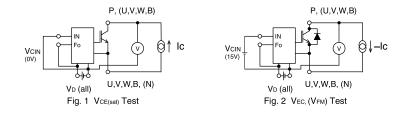


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PRECAUTIONS FOR TESTING

- 1. Before applying any control supply voltage (VD), the input terminals should be pulled up by resistors, etc. to their corresponding supply voltage and each input signal should be kept off state. After this, the specified ON and OFF level setting for each input signal should be done.
- 2. When performing "SC" tests, the turn-off surge voltage spike at the corresponding protection operation should not be allowed to rise above VCES rating of the device.

(These test should not be done by using a curve tracer or its equivalent.)



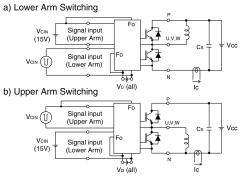


Fig. 3 Switching time and SC test circuit

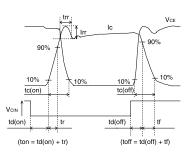


Fig. 4 Switching time test waveform

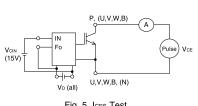


Fig. 5 Ices Test

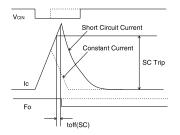
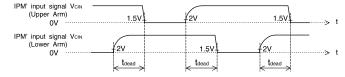


Fig. 6 SC test waveform



1.5V: Input on threshold voltage Vth(on) typical value, 2V: Input off threshold voltage Vth(off) typical value

Fig. 7 Dead time measurement point example



FLAT-BASE TYPE INSULATED PACKAGE

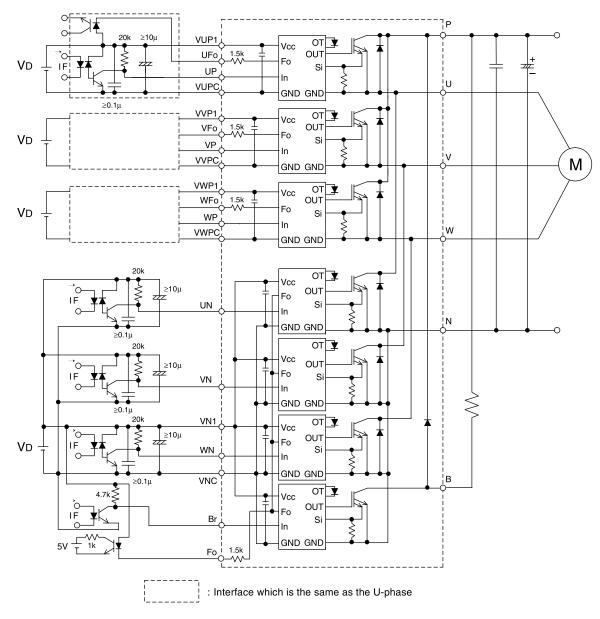


Fig. 8 Application Example Circuit

NOTES FOR STABLE AND SAFE OPERATION;

- Design the PCB pattern to minimize wiring length between opto-coupler and IPM's input terminal, and also to minimize the stray capacity between the input and output wirings of opto-coupler.
- Connect low impedance capacitor between the Vcc and GND terminal of each fast switching opto-coupler.
- Fast switching opto-couplers: tPLH, tPHL ≤ 0.8μs, Use High CMR type.
- ●Slow switching opto-coupler: CTR > 100%
- Use 4 isolated control power supplies (VD). Also, care should be taken to minimize the instantaneous voltage charge of the power supply.
- Make inductance of DC bus line as small as possible, and minimize surge voltage using snubber capacitor between P and N terminal.
- Use line noise filter capacitor (ex. 4.7nF) between each input AC line and ground to reject common-mode noise from AC line and improve noise immunity of the system.



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PERFORMANCE CURVES (Inverter Part)

OUTPUT CHARACTERISTICS (TYPICAL) 100 Tj = 25°C 90 COLLECTOR CURRENT Ic (A) 5V 80 VD = 17V70 60 1**3**\ 50 40 30 20 10 0, 0.5 1.5 2.0

COLLECTOR-EMITTER VOLTAGE VCE (V)

COLLECTOR-EMITTER SATURATION VOLTAGE (VS. Ic) CHARACTERISTICS (TYPICAL) 2.0 VD = 15V COLLECTOR-EMITTER SATURATION VOLTAGE VCE(sat) (V) 1.6 1.4 1.2 1.0 0.8 0.6 0.4 $T_j = 25^{\circ}C$ 0.2 **--** Tj = 125°C

0 6

20

COLLECTOR CURRENT Ic (A)

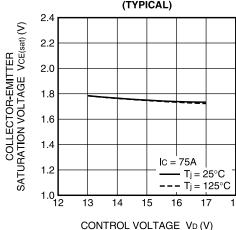
40

60

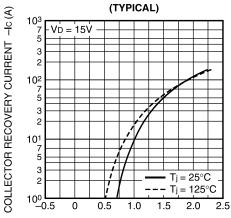
80

100

COLLECTOR-EMITTER SATURATION VOLTAGE (VS. VD) CHARACTERISTICS (TYPICAL)

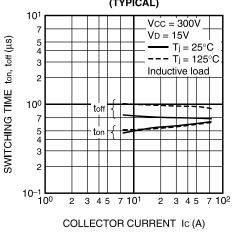


DIODE FORWARD CHARACTERISTICS

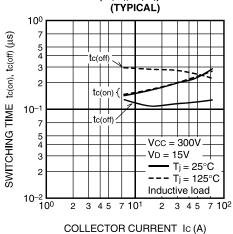


EMITTER-COLLECTOR VOLTAGE VEC (V)

SWITCHING TIME (ton, toff) CHARACTERISTICS (TYPICAL)



SWITCHING TIME (tc(on), tc(off)) CHARACTERISTICS





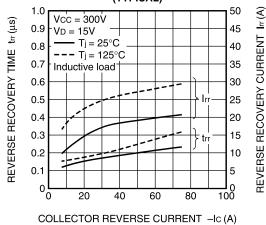
FLAT-BASE TYPE INSULATED PACKAGE

(TYPICAL) 4.0 Eon, Eoff (mJ/pulse) Vcc = 300V -VD = 15V 3.5 - Tj = 25°C 3.0 --- Tj = 125°C Inductive load 2.5 2.0 SWITCHING LOSS 1.5 Eoff 1.0 0.5

0

SWITCHING LOSS CHARACTERISTICS

DIODE REVERSE RECOVERY CHARACTERISTICS (TYPICAL)



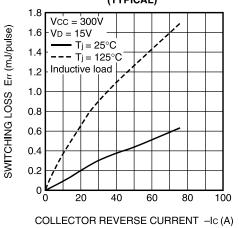
SWITCHING RECOVERY LOSS CHARACTERISTICS (TYPICAL)

COLLECTOR CURRENT Ic (A)

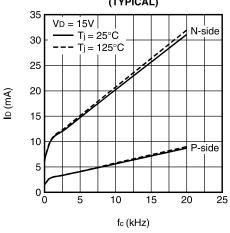
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80

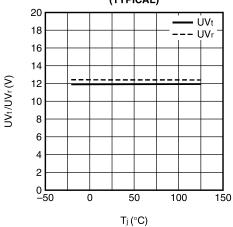
100



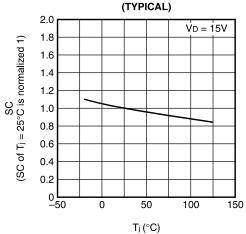
ID VS. fc CHARACTERISTICS (TYPICAL)



UV TRIP LEVEL VS. Ti CHARACTERISTICS (TYPICAL)



SC TRIP LEVEL VS. Ti CHARACTERISTICS



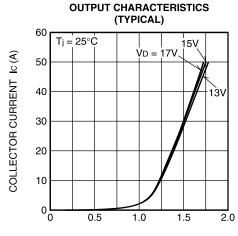


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TRANSIENT THERMAL **IMPEDANCE CHARACTERISTICS** (TYPICAL) 100 NORMALIZED TRANSIENT THERMAL IMPEDANCE Zth(j-c) 3 Single Pulse IGBT part; Per unit base = Rth(j-c)Q = 0.37FWDi part; Per unit base = Rth(j-c)F = 0.63°C/W 10-523 5710-423 5710-323 5710-223 5710-123 57100 23 57101

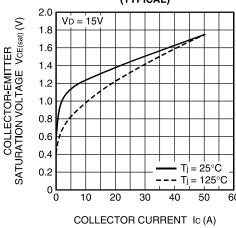
TIME t (sec)

(Brake Part)

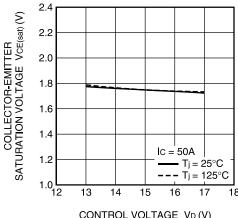


COLLECTOR-EMITTER VOLTAGE VCE (V)

COLLECTOR-EMITTER SATURATION VOLTAGE (VS. Ic) CHARACTERISTICS (TYPICAL)

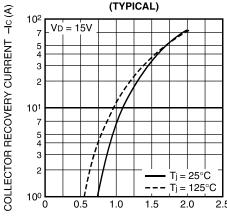


COLLECTOR-EMITTER SATURATION VOLTAGE (VS. VD) CHARACTERISTICS (TYPICAL)



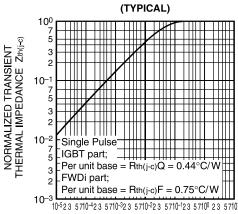
CONTROL VOLTAGE VD (V)

DIODE FORWARD CHARACTERISTICS



EMITTER-COLLECTOR VOLTAGE VEC (V)

TRANSIENT THERMAL **IMPEDANCE CHARACTERISTICS**



TIME t (sec)



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